LS8 Package
8-Pin Leadless Chip Carrier (5mm × 5mm)
(Reference LTC DWG # 05-08-1852 Rev B)

NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS
2. DRAWING NOT TO SCALE
3. DIMENSIONS PACKAGE DO NOT INCLUDE PLATING BURRS
   PLATING BURRS, IF PRESENT, SHALL NOT EXCEED 0.30mm ON ANY SIDE
4. PLATING—ELECTRO NICKEL MIN 1.25UM, ELECTRO GOLD MIN 0.30UM
5. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE
   TOP AND BOTTOM OF PACKAGE

PACKAGE OUTLINE

APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED

COMPONENT PIN "A1"

PACKAGE IN TRAY LOADING ORIENTATION

COMPONENT PIN 1 BEVEL

TRAY PIN 1 BEVEL

PIN 1 TOP MARK
(SEE NOTE 5)